MOS FIELD EFFECT TRANSISTOR 2SK2353/2SK2354

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

NEC

The 2SK2353/2SK2354 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-Resistance
 2SK2353: R_{DS(on)} = 1.4 Ω (V_{GS} = 10 V, I_D = 2.5 A)
 2SK2354: R_{DS(on)} = 1.5 Ω (V_{GS} = 10 V, I_D = 2.5 A)
- Low C_{iss} C_{iss} = 670 pF TYP.
- High Avalanche Capability Ratings
- Isolate TO-220 Package

QUALITY GRADE

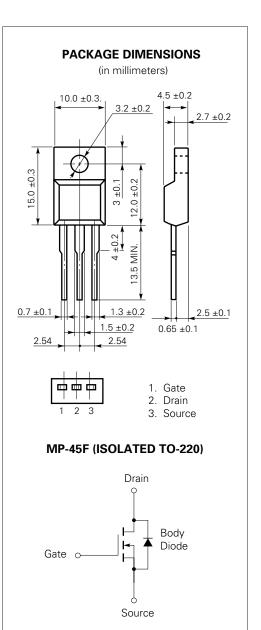
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2353/2354)	Vdss	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±4.5	А
Drain Current (pulse)*	D(pulse)) ±18	А
Total Power Dissipation (T _c = 25 $^{\circ}$ C)	P⊤1	30	W
Total Power Dissipation ($T_a = 25$ °C)	Р т2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg -	-55 to +150	°C
Single Avalanche Current**	las	4.5	А
Single Avalanche Energy**	Eas	17.4	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



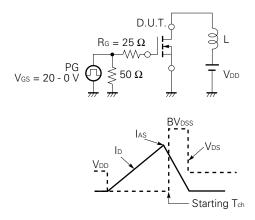
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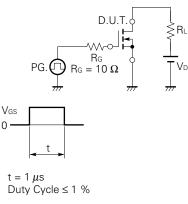
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

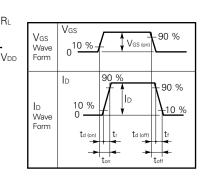
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS(on)		1.0	1.4	Ω	$V_{GS} = 10 V$	2SK2353
			1.1	1.5		ID = 2.5 A	2SK2354
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	Vds = 10 V, Id = 1 mA	
Forward Transfer Admittance	y _{fs}	1.0			S	Vds = 10 V, Id = 2.5 A	
Drain Leakage Current	IDSS			100	μΑ	Vds = Vdss, Vgs = 0	
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$	
Input Capacitance	Ciss		670		pF	$V_{DS} = 10 V$	
Output Capacitance	Coss		140		pF	V _{GS} = 0	
Reverse Transfer Capacitance	Crss		18		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		11		ns	ID = 2.5 A	
Rise Time	tr		8		ns	$V_{GS(on)} = 10 V$	
Turn-Off Delay Time	td(off)		40		ns	Vdd = 150 V	
Fall Time	tr		8		ns	R_G = 10 Ω R_L = 60 Ω	
Total Gate Charge	QG		20		nC	ID = 4.5 A	
Gate to Source Charge	Q _{GS}		4.5		nC	$V_{DD} = 400 V$	
Gate to Drain Charge	Qgd		9		nC	Vgs = 10 V	
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 4.5 A, VGS = 0	
Reverse Recovery Time	trr		270		ns	IF = 4.5 A, Vo	as = 0
Reverse Recovery Charge	Qrr		1.0		nC	di/dt = 50 A/	μs

Test Circuit 1 Avalanche Capability

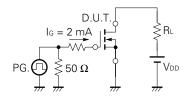
Test Circuit 2 Switching Time



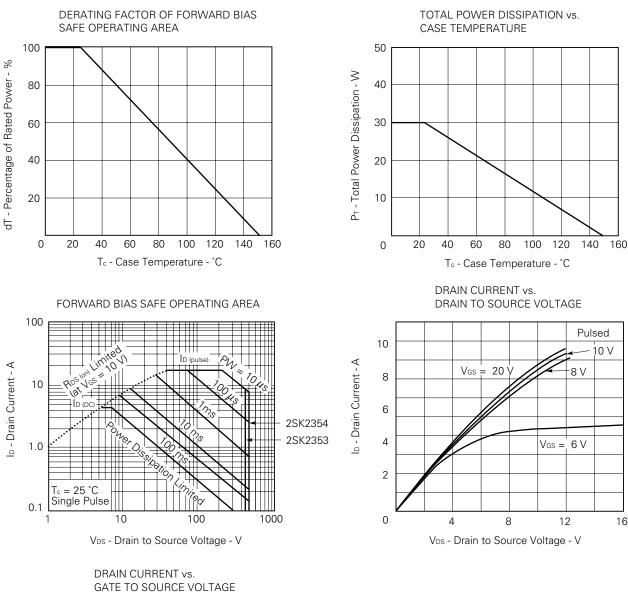




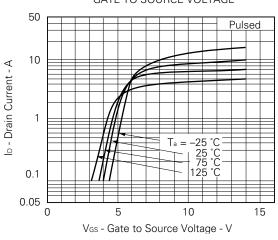
Test Circuit 3 Gate Charge



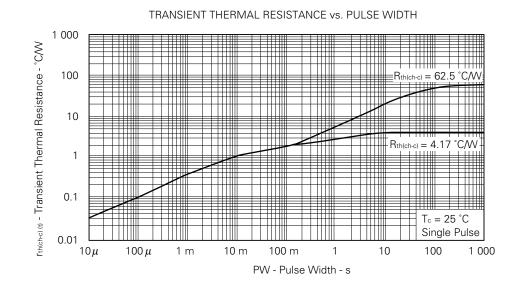
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



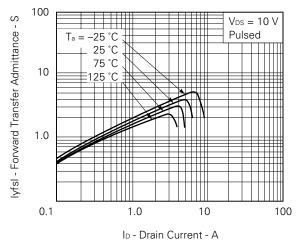
TYPICAL CHARACTERISTICS (TA = 25 °C)

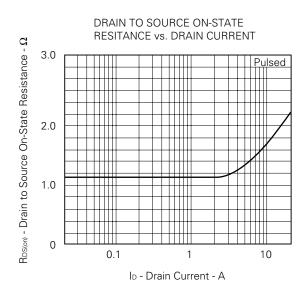


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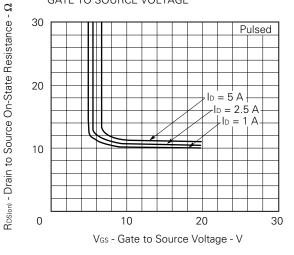




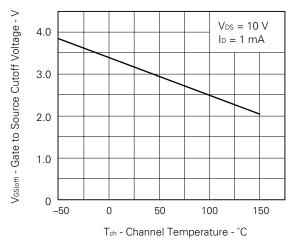


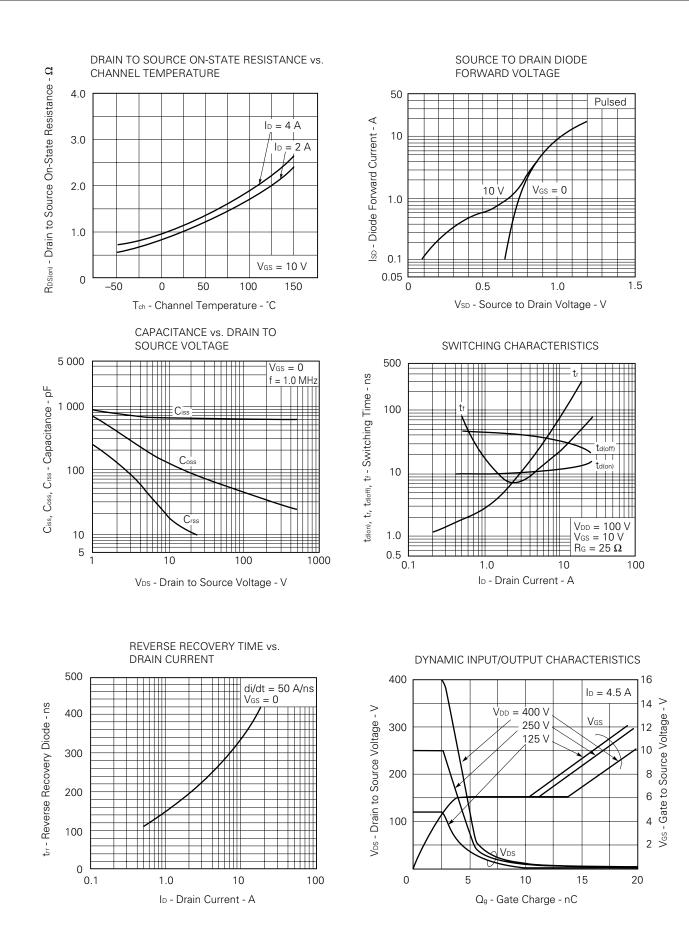


DRAIM TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

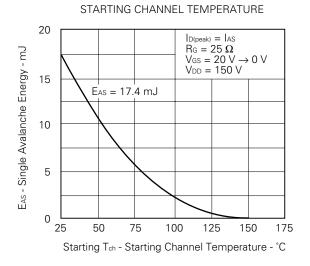




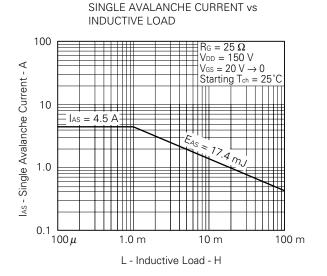




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SINGLE AVALANCHE ENERGY vs



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Application examples recommended by NEC Corporation

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